# Rocktech Displays Limited



Version:	1.0
Description	: 7.0 inch TFT 1024*600 pixels with LED

backlight ,All viewing angle,MIPI interface,

1000 nits luminance

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# **Revision History**

Date	Rev.	Page	Description
2019-08-16	1.0	All	First Issue



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# 1. General Features

Item	Spec	Remark
Display Mode	Normally Black transmissive	
Viewing Direction	Free	
Input Signals	MIPI	
Outside Dimensions(mm)	164.9 (W) x100(H) x5.7 (D)	
Active Area(mm)	154.21(W)×85.92(H)	
Number of Pixels	1024(RGB)×600	
Dot Pitch(mm)	0.1506 (H) x 0.1432 (V)	
Pixel Arrangement	RGB Vertical stripes	
Drive IC		



# 2. Absolute Maximum Ratings

The following are maximum values which, if exceeded may cause operation or damage to the unit.

ITEM	Sym.	Min.	Тур.	Max.	Unit	Remark
	VDD	-0.3	1	+2.0	V	
Power for Circuit Driving	AVDD	-0.5		15.0	V	
Power for Circuit Driving	VGH	-0.3		40	V	
	VGL	-20		0.3	V	
Storage Humidity	H <sub>ST</sub>	10	1		%RH	
Storage Temperature	T <sub>ST</sub>	-30	-	80	$^{\circ}\!\mathbb{C}$	At
Operating Ambient Humidity	H <sub>OP</sub>	10	1		%RH	<b>25±5</b> ℃
Operating Ambient temperature	T <sub>OP</sub>	-20	-	70	$^{\circ}\!\mathbb{C}$	



# 3. Electrical Specification

#### 3.1 Driving TFT LCD Panel

Item	Symbol	Min.	Тур.	Max.	Unit	Note
	VDD	1.71	1.8	1.89	V	
Supply Voltage	Vgн	17	18	19	V	
	VGL	-6.6	-6	-5.4	V	
	AVDD	9.4	9.6	9.8	V	
	Vcom	3.6	3.8	4.0		
Video signal	VIA	-	-	AV <sub>DD</sub> -0.4	V	
amplitude	VIAC	-	-	-	V	AC component,
(VR,VG,VB)	VIDC	-	AVDD/2	-	V	DC component
VCOM	Vcac		-	-	VP-P	AC component
VCOM	Vcdc	-	-	-	V	DC component, (1)
Input signal	ViH	0.7DVpp	-	DVDD	V	(2)
voltage	VIL	0	-	0.3DVpp	V	(2)
	IDD	-	30	45	mA	DV DD=3.3V
Current of power	IADD	-	35	45	mA	AVDD=9.6V
Current or power	Igн		0.5	1	uA	V <sub>GH</sub> =18V
supply	IGL	-	0.5	1	mA	V <sub>G</sub> L=-6V

Note (1): The brightness of LCD panel could be changed by adjusting the AC component of VCOM.

Note (2): STHL, STHR, OEH, L/R, CPH1~CPH3, STVD, STVU, OEV, CKV, U/D

#### 3.2 Driving LED Backlight

Item	Sym.	Min	Тур.	Max	Unit	Note
Backlight driving voltage	VF	9.0	9.6	10.2	V	
Backlight driving current	lF	-	270	-	mA	
Backlight Power Consumption	WBL	-	2592	-	mW	
Life Time	-	-	30,000	-		Note 1

Note 1: If LED is driven by high current, high ambient temperature & humidity condition. The life time of LED will be reduced. Operating life means brightness goes down to 50% initial brightness. Typical operating life time is estimated data.



#### 3.3 Power Consumption

ITEM	SYMBOL	CONDITION	MIN	TYPE	MAX	UNIT	NOTE
Gate on power current	IVGH	VGH =18V		0.5	1	mA	Note1
Gate off power current	IVGL	VGL= -6V		0.5	1	mA	Note1
Digital power current	IDVDD	DVDD = 3.3V		30	45	mA	Note1
Analog power current	IAVDD	AVDD = 9.6V		35	45	mA	Note1
Total Power Consumption	PC			447	604	mW	Note1

Note1: Typ. specification : Gray-level test Pattern Max. specification : Black test Pattern







Black Pattern



# **4.Optical Specifications**

Optical characteristics are determined after the unit has been 'ON' and stable for approximately 30 minutes in a dark environment at 25 °C. The values specified are at an approximate distance 500mm from the LCD surface at a viewing angle of  $\Phi$  and  $\theta$  equal to  $0^{\circ}$ .

Mana.	0		Values			Mata
ltem	Sym.	Min.	Тур.	Max.	Unit	Note
1)Contrast Ratio	C/R	-	800	-		FIG.1
2)Module Luminance	L	-	1000	-	cd/m <sup>2</sup>	
3)Response time	Tr+Tf	-	35	-	ms	FIG.2
	$\theta_{T}$	-	85	-		
4)\/ioving Angle	$\theta_{B}$	-	85	-	Dograd	FIC 2
4)Viewing Angle	$\theta_{L}$	-	85	-	Degree	FIG.3
	$\theta_{R}$	-	85	-		
	Wx	0.27	0.31	0.35		
	Wy	0.29	0.33	0.37		
	Rx	-	-	-		
5)Chromaticity	Ry	-	-	-		
	Gx	-	-	-		
	Gy	-	-	-		
	Bx	-	-	-		
	Ву	-	-	-		



#### **♦ Measurement System**

Notes:

1. Contrast Ratio(CR) is defined mathematically as:

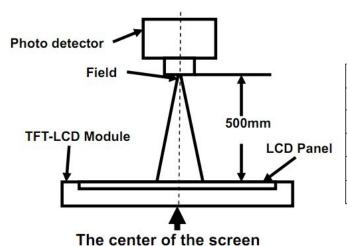
#### Surface Luminance with all white pixels

Contrast Ratio = ------

#### Surface Luminance with all black pixels

- 2. Surface luminance is the center point across the LCD surface 500mm from the surface with all pixels displaying white. For more information see FIG 1.
- 3. Response time is the time required for the display to transition from white to black (Rising Time, Tr) and from black to white (Falling Time, Tf). For additional information see FIG 2.
- 4. Viewing angle is the angle at which the contrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

#### FIG. 1 Optical Characteristic Measurement Equipment and Method



Item	Photo detector	Field	
Contrast Ratio		1°	
Luminance	OD 24		
Chromaticity	SR-3A	1	
Lum Uniformity			
Response Time	BM-7A	2°	

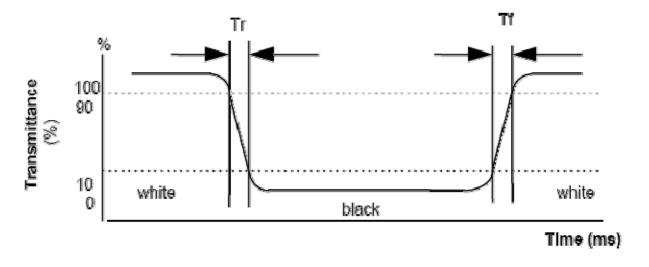


#### FIG. 2 The definition of Response Time

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".

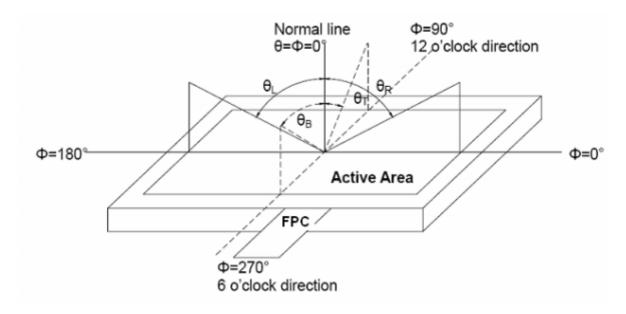
Response Time = Rising Time(Tr) + Falling Time(Tf)

- Rising Time(Tr): Full White 90% → Full White 10% Transmittance.
- Falling Time(Tf): Full White 10% → Full White 90% Transmittance.



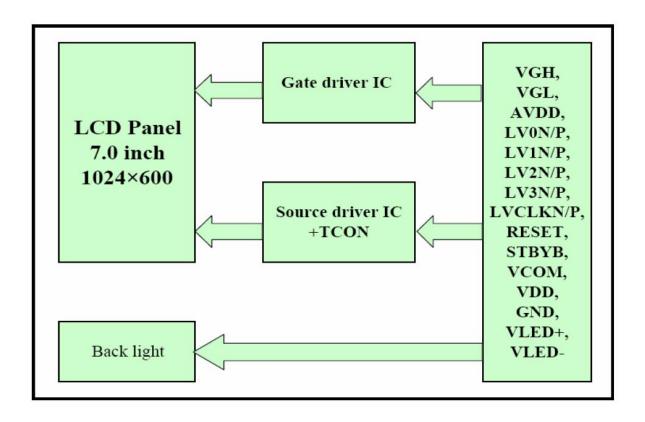
# FIG. 3 The definition of Viewing Angle

Use Fig. 1(Test Procedure) under Measurement System to measure the contrast from the measuring direction specified by the conditions as the following figure.





# 5. Block Diagram





# 6.Pin Description 6.1 TFT LCD Panel

PIN No.	Symbol	I/O	Function	Remark
1	VCOM	Р	Common Voltage	
2	VDD	Р	Power Supply 1.8V	
3	VDD	Р	Power Supply 1.8V	
4	NC	-	No connection	
5	RESET	I	Global reset pin. Active low to enter reset state.	
6	STBYB	I	STBYB=1, normal operation. STBYB=0, timing control, source driver will turn off, all output are high-Z	
7	GND	Р	Ground	
8	D0N	I/O	Positive MIPI differential data input	
9	D0P	I/O	Negative MIPI differential data input	
10	GND	Р	Ground	
11	D1N	I/O	Positive MIPI differential data input	
12	D1P	I/O	Negative MIPI differential data input	
13	GND	Р	Ground	
14	D2N	I/O	Positive MIPI differential data input	
15	D2P	I/O	Negative MIPI differential data input	
16	GND	Р	Ground	
17	DCLKN	I/O	Positive MIPI differential clock input	
18	DCLKP	I/O	Negative MIPI differential clock input	
19	GND	Р	Ground	
20	D3N	I/O	Positive MIPI differential data input	
21	D3P	I/O	Negative MIPI differential data input	
22	GND	Р	Ground	
23	NC	-	No connection	
24	NC	-	No connection	
25	GND	Р	Ground	
26	NC	-	No connection	
27	NC	-	No connection	
28	NC	-	No connection	
29	AVDD	Р	Power for Analog Circuit	



30	GND	Р	Ground	
31	LED-	Р	LED Cathode	
32	LED-	Р	LED Cathode	
33	L/R	I	Left/Right display control	Refer to 6.2
34	U/D	I	Up/Down display control	Refer to 6.2
35	VGL	Р	Gate OFF Voltage	
36	NC	-	No connection	
37	NC	-	No connection	
38	VGH	Р	Gate ON Voltage	
39	LED+	Р	LED Anode	
40	LED+	Р	LED Anode	

# **6.2 U/D R/L Function Description**

Scan Con	trol Input	Seanning Direction
UPDN	SHLR	Scanning Direction
GND	VDD	Up to Down, Left to Right
VDD	GND	Down to Up, Right to Left
GND	GND	Up to Down, Right to Left
VDD	VDD	Down to Up, Left to Right



# 7. Timing Characteristics

# 7.1 Input Timing Table

DE mode

Parameter	Symbol		l lmi4		
Faiailletei		Min.	Тур.	Max.	Unit
DCLK frequency @Frame rate=60hz	fclk	40.8	51.2	67.2	Mhz
Horizontal display area	thd		DCLK		
HSYNC period time	th	1114	1344	1400	DCLK
HSYNC blanking	thb+thfp	90	320 (	376	DCLK
Vertical display area	Tvd		600		Н
VSYNC period time	Tv	610	635	<b>W</b> 800	Н
VSYNC blanking	Tvb+Tvfp	10	1/39	200	Н

HV mode

Horizontal input timing

Parameter	Symbol		Value		Unit
Horizontal display area	that		1024		DCLK
DCLK fraguency@ Frame rate 790hz	fclk (	Min.\	Тур.	Max.	
DCLK frequency@ Frame rate=60hz	) ICIK (	449	51.2	63	Mhz
1 Horizontal Line	(th)	200	1344	1400	
Min.	5// V/		1		
HSYNC pulse width Typ:	thpw		70		DOLK
Max	7		140		DCLK
HSYNC blanking	thb	160	160	160	
HSYNC front porety	thfp	16	160	216	

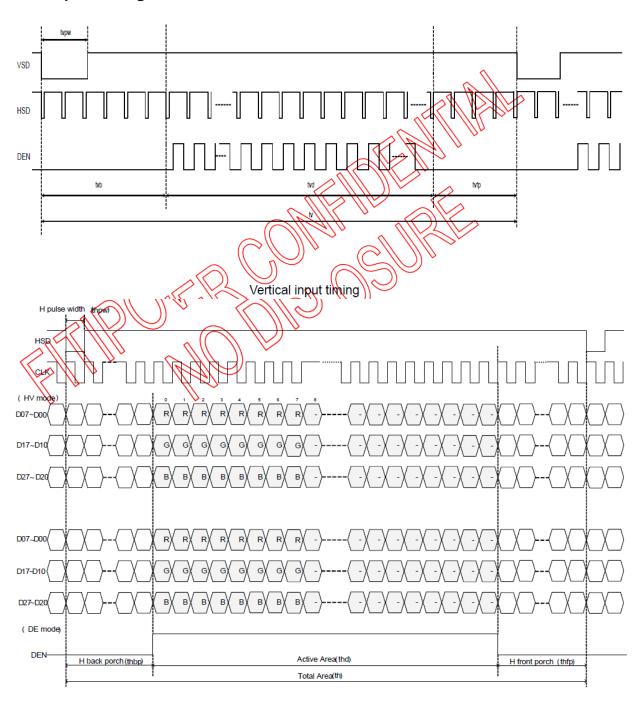
HV mode

Vertical input timing

Parameter	Symbol		Unit		
		Min.	Тур.	Max.	Onit
Vertical display area	tvd		600		Н
VSYNC period time	tv	624	635	750	Н
VSYNC pulse width	tvpw	1	10	20	Н
VSYNC back porch	tvb	23	23	23	Н
VSYNC front porch	tvfp	1	12	127	Н



# 7.2 Input Timing

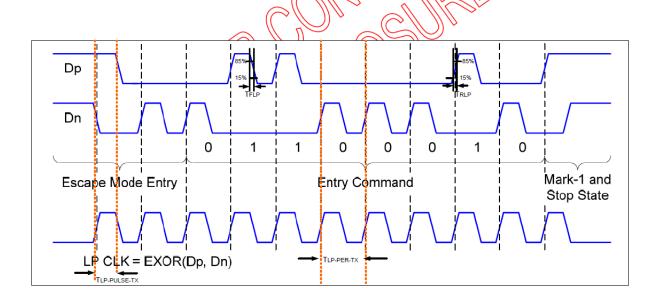


Horizontal input timing



#### 7.3 LP Transmitter AC characteristic

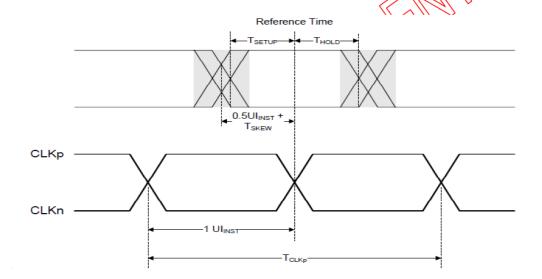
Parameter		Symbol	Min	Тур	Max	Units	Notes
15%~85% risir	15%~85% rising time and falling time		-	-	25	ns	-
30%~85% risir	ng time and falling time	TREOT	-	-	35	ns	-
Pulse width	First LP EXOR clock						-
of LP	pulse after STOP state or				(		
exclusive-OR	Last pulse before stop	TLP-PULSE-TX	40	-	- 6	\\ ns	
clock	state				$\mathcal{U} \cap \mathcal{U}$		
	All other pulses		20	- <<	X -\\ \\ \\ \\ \	ns	-
Period of the L	P EXOR clock	T <sub>LP-PER-TX</sub>	90	~ //	/ //- //n	mV/ns	-
Slew Rate @C	CLOAD =0pF		30		500	mV/ns	-
Slew Rate @CLOAD =5pF		δ V/δ tsr	30		200	mV/ns	-
Slew Rate @CLOAD =20pF			30		150	mV/ns	-
Slew Rate @C	LOAD =70pF	]	30\\\	( )) -	100	mV/ns	-
Load Capacitance		TRLP		<b>~</b>	<b>70</b>	pF	-





# 7.4 High speed transmission

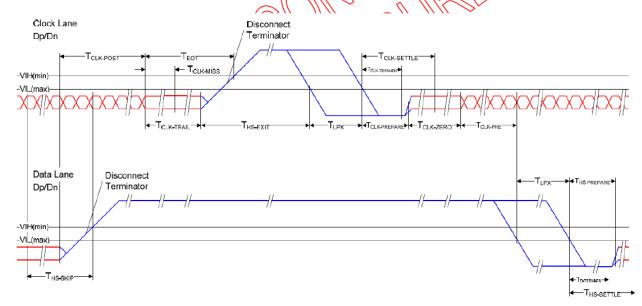
Parameter	Symbol	Min	Тур	Max	Units
UI instantaneous	UIINST	2	-	12.5	ns
Data to Clock	T <sub>SKEW(TX)</sub>	-0.15	-	0.15	UIINST
Skew(measured at					
transmitter)					
Data to Clock Setup	TSETUP(RX)	0.15	-	-	Ulinst
time(measured at receiver)					
Data to Clock Hold	THOLD(RX)	0.15	-	- 1	UIINST
time(measured at receiver)				1 M 2	_
20%~80% rise time and fall	T <sub>R</sub> , T <sub>F</sub>	150	-	21/12	ps
time		-	- <	0.3	UIINST



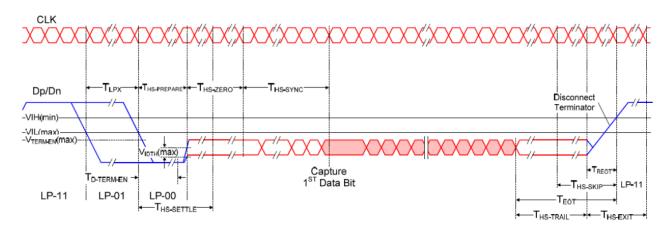


# 7.5 High speed clock transmission

Parameter	Symbol	Min	Тур	Max	Units
Time that the transmitter shall continue sending HS clock after the last associated Data Lane has transitioned to LP mode	Tclk-post	60+52UI	-	-	ns
Detection time that the clock has stopped toggling	Tclk-miss	-	-	60	ns
Time to drive LP-00 to prepare for HS clock transmission	TCLK-PREPARE	38	-	95	ns
Minimum lead HS-0 drive period before starting clock	TCLK-PREPARE + TCLK-ZERO	300	200		ns
Time to enable Clock Lane receiver line termination measured from when Dn cross V <sub>IL,MAX</sub>	Ths-term-en		<u> </u>	38	ns
Minimum time that the HS clock must be prior to any associated data lane beginning the transmission from LP to HS mode	Tclk-pre	8	_	-	UI
Time to drive HS differential state after last payload clock bit of a HS transmission burst	TCLK-TRAIL	60		-	ns



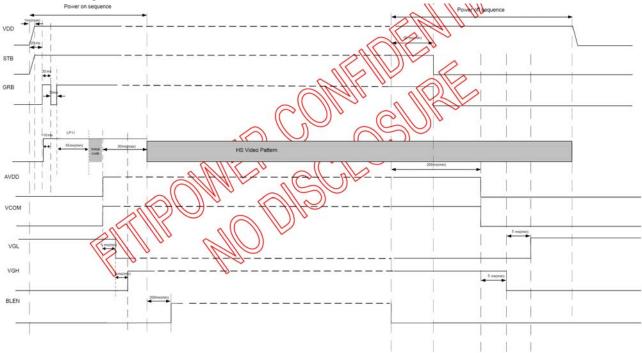
#### 7.6 High speed data transmission in bursts





#### 7.7 Power On/Off Sequence

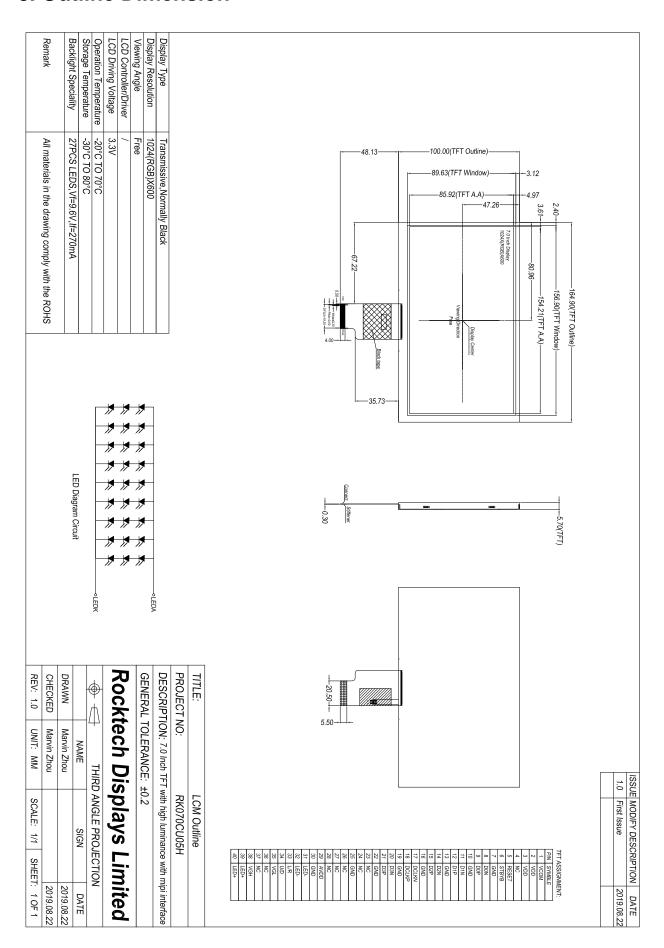
In order to prevent IC from power on reset fail, the rising time (TPOR) of the digital power supply VDD should be maintained within the given specifications. Refer to "AC Characteristics" for more detail on timing.



Note: CLK and Data Lanes should keep in LP11(stop state) before GRB.



# 8. Outline Dimension





# 9. Reliability and Inspection Standard

No.	Test Item		Test Conditions	Remark
1	Storage Storage		80℃, 120Hr	Note
'	High Temperature	Operation	<b>70</b> ℃, <b>120</b> Hr	Note
2	Storage		Storage -30℃, 120Hr	
	Low Temperature	Operation	-20℃, 120Hr	Note
3	High Temperature and High Humidity		gh 40℃, 90%RH, 120Hr	
4	Thermal Cycling Test(No operation)		-20℃ for 30min, 70℃ for 30 min. 100 cycles. Then test at room temperature after 1 hour	Note
5	Vibration Test(No operation)		Frequency:10~55 HZ; Stroke:1.5 mm;Sweep:10HZ~55HZ~10HZ; 2hours for each direction of X, Y, Z(6 hours for total)	
6	Package Drop Test		Height:60 cm,1 corner, 3 edges, 6 surfaces	
7	Electro Static Discharge		$\pm$ 2KV,Human Body Mode, 100pF/1500 $\Omega$	

#### Note:

- 1) Sample quantity for each test item is 5~10pcs.
- 2) Note 4: Before cosmetic and function test, the product must have enough recovery time, at least 2 hours at room temperature.



#### 10.PRECAUTIONS FOR USING LCD MODULES

#### **Handing Precautions**

- (1) The display panel is made of glass and polarizer. As glass is fragile, it tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.
- (2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.
- (3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).
- (4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
- (5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents
  - Isopropyl alcohol
  - Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

- (6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.
  - Water
  - Ketone
  - Aromatic solvents
  - Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contacting oil and fats.
- (7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- (8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.
- (9) Do not attempt to disassemble or process the LCD module.
- (10) NC terminal should be open. Do not connect anything.
- (11) If the logic circuit power is off, do not apply the input signals.
- (12) Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.
  - Do not alter, modify or change the shape of the tab on the metal frame.
  - Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
  - Do not damage or modify the pattern writing on the printed circuit board.
  - Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal



connector.

- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- Do not drop, bend or twist LCM.

#### **Storage Precautions**

When storing the LCD modules, the following precaution is necessary.

- (1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for the dessicant.
- (2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C.
- (3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the container in which they were shipped).

#### **Others**

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature. If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

- Exposed area of the printed circuit board.
- -Terminal electrode sections.